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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Wilk, et al. Docket: TI-24742  
Appl. No.: 09/176,422 Examiner: K. Nguyen  
Filed: 10/21/98 Art Unit: 2823  
Conf. No. 8175  
For: Low Temperature Method for Forming a Thin, Uniform Oxide

**LETTER TO OFFICIAL DRAFTSPERSON UNDER 37 CFR 1.84**

January 12, 2006

Mail Stop Issue Fee  
Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8  
I hereby certify that this correspondence is being deposited  
with the United States Postal Service as first class mail in an  
envelope addressed to: Commissioner for Patents, P.O.  
Box 1450, Washington, DC 22313-1450 on

January 18, 2006.  
*Tina Smith*  
Tina Smith

Draftsperson:

Applicants submit 2 sheets of formal drawings for the above-identified  
application. Please charge any necessary fees to the deposit account of Texas  
Instruments Incorporated, Account No. 20-0668.

Respectfully submitted,

*David Denker*  
David Denker  
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